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What is "Embedded - Microcontrollers"?

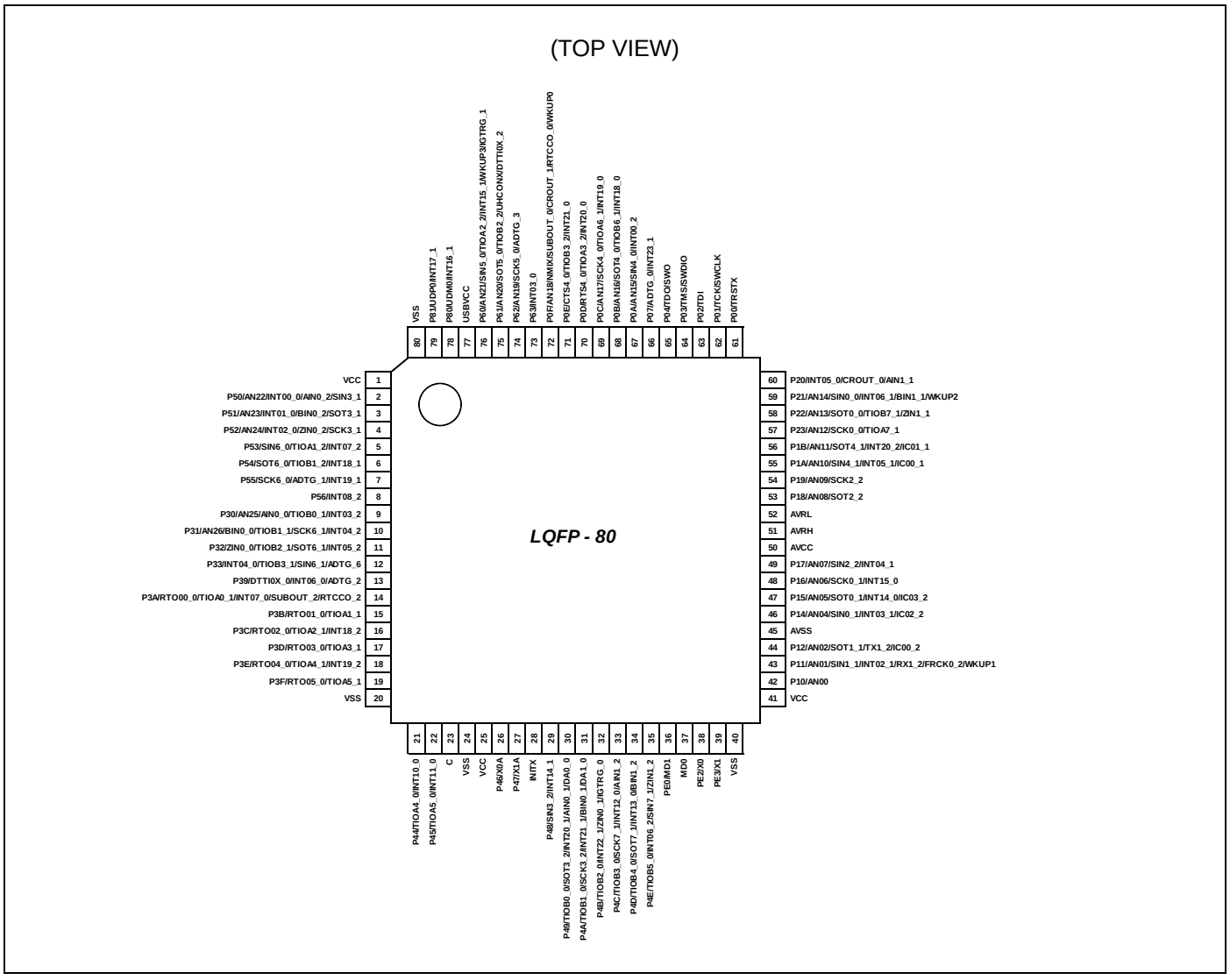
"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	ARM® Cortex®-M3
Core Size	32-Bit Single-Core
Speed	72MHz
Connectivity	CANbus, CSIO, I²C, LINbus, UART/USART, USB
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	35
Program Memory Size	288KB (288K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	32K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 14x12b; D/A 2x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 105°C (TA)
Mounting Type	Surface Mount
Package / Case	48-LQFP
Supplier Device Package	48-LQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/mb9bf524kpmc-g-jne2

3. Pin Assignment

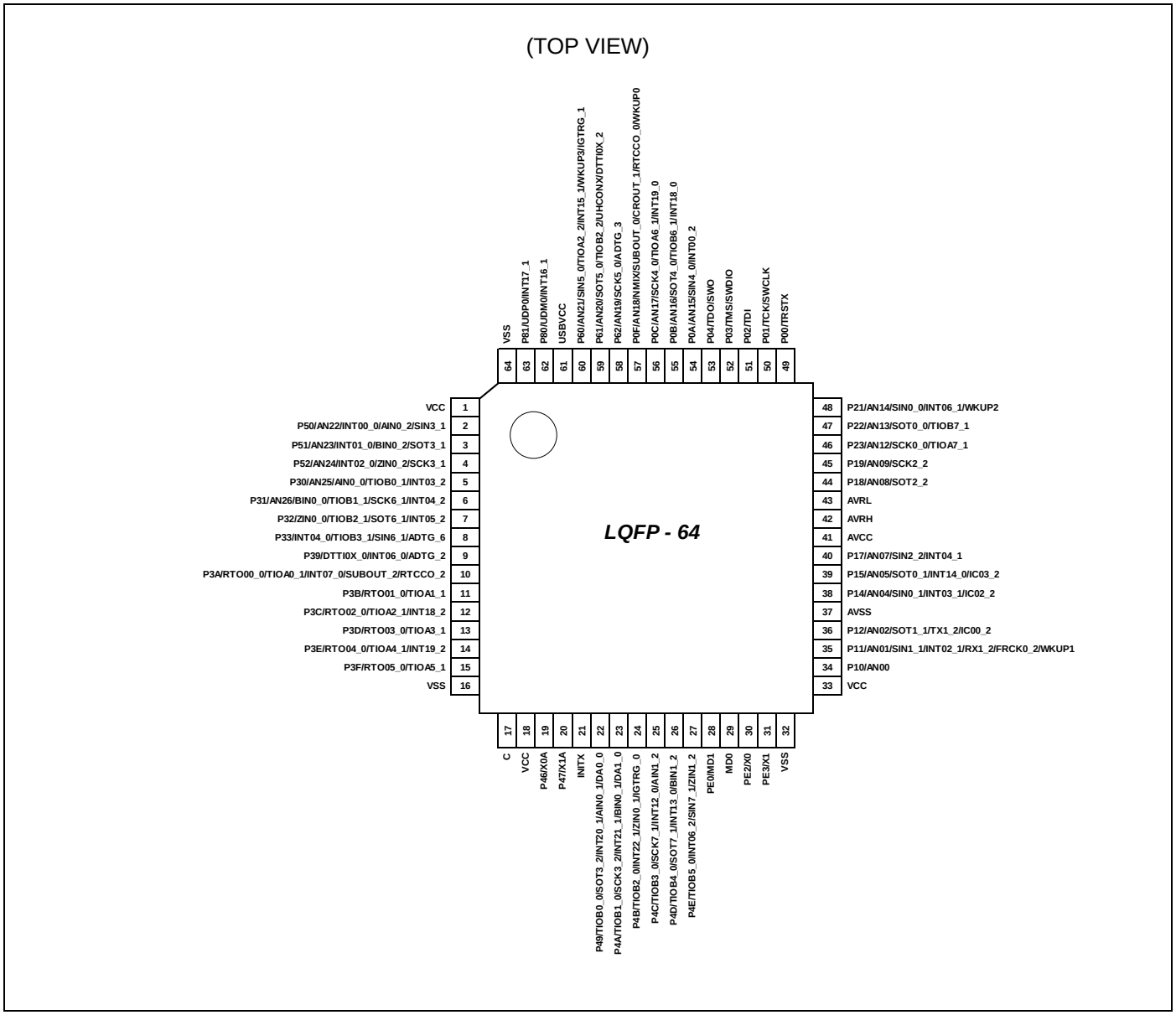
FPT-80P-M37/M40



Note:

The number after the underscore ("_") in pin names such as XXX_1 and XXX_2 indicates the relocated port number. For these pins, there are multiple pins that provide the same function for the same channel. Use the extended port function register (EPFR) to select the pin.

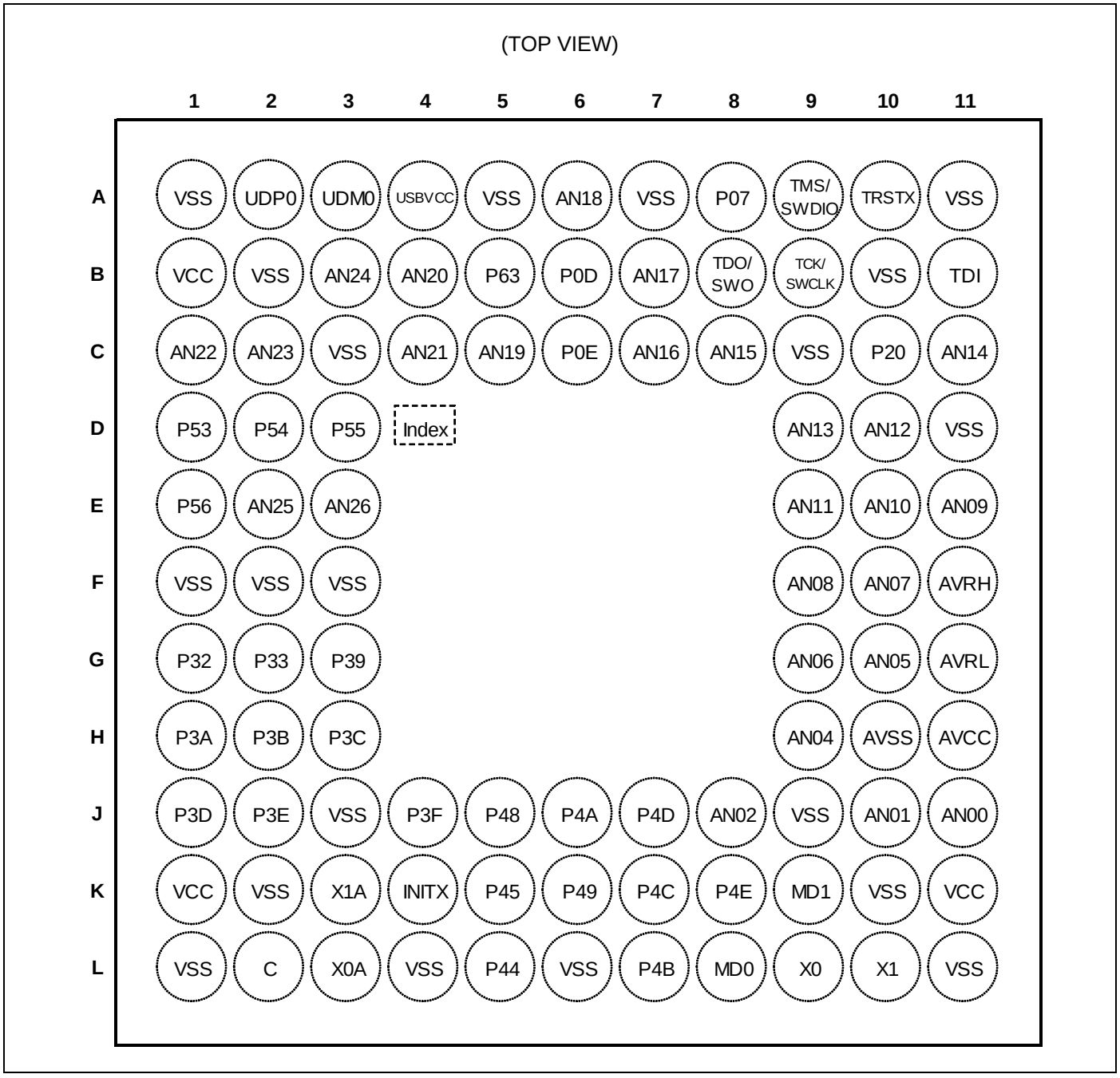
FPT-64P-M38/M39



Note:

The number after the underscore ("_") in pin names such as XXX_1 and XXX_2 indicates the relocated port number. For these pins, there are multiple pins that provide the same function for the same channel. Use the extended port function register (EPFR) to select the pin.

BGA-96P-M07



Note:

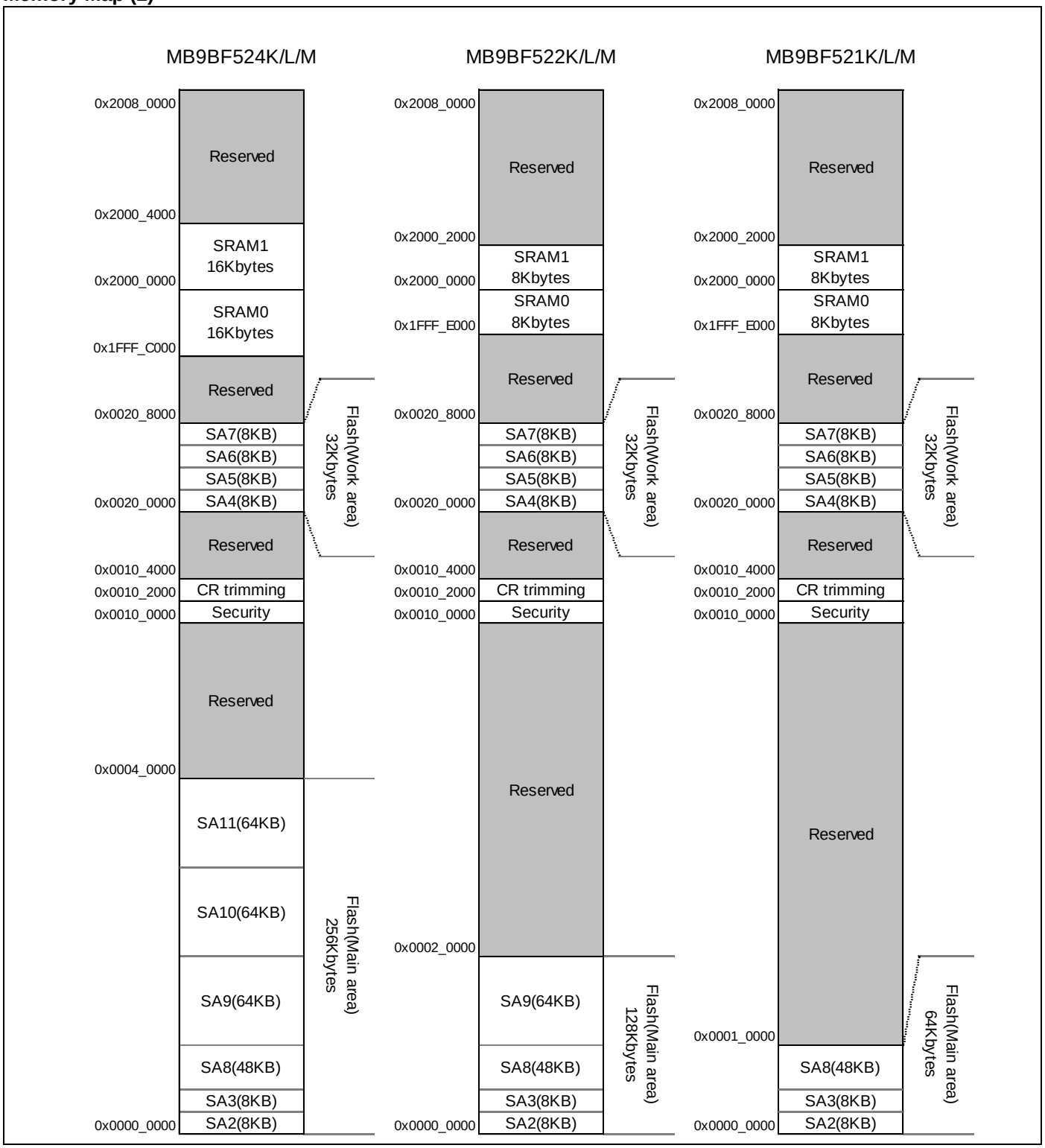
The number after the underscore ("_") in pin names such as XXX_1 and XXX_2 indicates the relocated port number. For these pins, there are multiple pins that provide the same function for the same channel. Use the extended port function register (EPFR) to select the pin.

Pin function	Pin name	Function description	Pin No			
			LQFP-80	BGA-96	LQFP-64 QFN-64	LQFP-48 QFN-48
Multi-function Serial 0	SIN0_0	Multi-function serial interface ch.0 input pin	59	C11	48	36
	SIN0_1		46	H9	38	29
	SOT0_0 (SDA0_0)	Multi-function serial interface ch.0 output pin. This pin operates as SOT0 when it is used in a UART/CSIO/LIN (operation modes 0 to 3) and as SDA0 when it is used in an I^2C (operation mode 4).	58	D9	47	35
	SOT0_1 (SDA0_1)		47	G10	39	30
	SCK0_0 (SCL0_0)	Multi-function serial interface ch.0 clock I/O pin. This pin operates as SCK0 when it is used in a CSIO (operation mode 2) and as SCL0 when it is used in an I^2C (operation mode 4).	57	D10	46	34
	SCK0_1 (SCL0_1)		48	G9	-	-
Multi-function Serial 1	SIN1_1	Multi-function serial interface ch.1 input pin	43	J10	35	26
	SOT1_1 (SDA1_1)	Multi-function serial interface ch.1 output pin. This pin operates as SOT1 when it is used in a UART/LIN (operation modes 0,1,3) .	44	J8	36	27
Multi-function Serial 2	SIN2_2	Multi-function serial interface ch.2 input pin	49	F10	40	-
	SOT2_2 (SDA2_2)	Multi-function serial interface ch.2 output pin. This pin operates as SOT2 when it is used in a UART/CSIO/LIN (operation modes 0 to 3) and as SDA2 when it is used in an I^2C (operation mode 4).	53	F9	44	-
	SCK2_2 (SCL2_2)	Multi-function serial interface ch.2 clock I/O pin. This pin operates as SCK2 when it is used in a CSIO (operation mode 2) and as SCL2 when it is used in an I^2C (operation mode 4).	54	E11	45	-
Multi-function Serial 3	SIN3_1	Multi-function serial interface ch.3 input pin	2	C1	2	2
	SIN3_2		29	J5	-	-
	SOT3_1 (SDA3_1)	Multi-function serial interface ch.3 output pin. This pin operates as SOT3 when it is used in a UART/CSIO/LIN (operation modes 0 to 3) and as SDA3 when it is used in an I^2C (operation mode 4).	3	C2	3	3
	SOT3_2 (SDA3_2)		30	K6	-	-
	SCK3_1 (SCL3_1)	Multi-function serial interface ch.3 clock I/O pin. This pin operates as SCK3 when it is used in a CSIO (operation mode 2) and as SCL3 when it is used in an I^2C (operation mode 4).	4	B3	4	4
	SCK3_2 (SCL3_2)		31	J6	-	-

Pin function	Pin name	Function description	Pin No			
			LQFP-80	BGA-96	LQFP-64 QFN-64	LQFP-48 QFN-48
Multi-function Serial 4	SIN4_0	Multi-function serial interface ch.4 input pin	67	C8	54	-
	SIN4_1		55	E10	-	-
	SOT4_0 (SDA4_0)	Multi-function serial interface ch.4 output pin. This pin operates as SOT4 when it is used in a UART/CSIO/LIN (operation modes 0 to 3) and as SDA4 when it is used in an I^2C (operation mode 4).	68	C7	55	-
	SOT4_1 (SDA4_1)		56	E9	-	-
	SCK4_0 (SCL4_0)	Multi-function serial interface ch.4 clock I/O pin. This pin operates as SCK4 when it is used in a CSIO (operation mode 2) and as SCL4 when it is used in an I^2C (operation mode 4).	69	B7	56	-
	RTS4_0	Multi-function serial interface ch.4 RTS output pin	70	B6	-	-
	CTS4_0	Multi-function serial interface ch.4 CTS input pin	71	C6	-	-
Multi-function Serial 5	SIN5_0	Multi-function serial interface ch.5 input pin	76	C4	60	44
	SOT5_0 (SDA5_0)	Multi-function serial interface ch.5 output pin. This pin operates as SOT5 when it is used in a UART/CSIO/LIN (operation modes 0 to 3) and as SDA5 when it is used in an I^2C (operation mode 4).	75	B4	59	43
	SCK5_0 (SCL5_0)	Multi-function serial interface ch.5 clock I/O pin. This pin operates as SCK5 when it is used in a CSIO (operation mode 2) and as SCL5 when it is used in an I^2C (operation mode 4).	74	C5	58	-
Multi-function Serial 6	SIN6_0	Multi-function serial interface ch.6 input pin	5	D1	-	-
	SIN6_1		12	G2	8	-
	SOT6_0 (SDA6_0)	Multi-function serial interface ch.6 output pin. This pin operates as SOT6 when it is used in a UART/CSIO/LIN (operation modes 0 to 3) and as SDA6 when it is used in an I^2C (operation mode 4).	6	D2	-	-
	SOT6_1 (SDA6_1)		11	G1	7	-
	SCK6_0 (SCL6_0)	Multi-function serial interface ch.6 clock I/O pin. This pin operates as SCK6 when it is used in a CSIO (operation mode 2) and as SCL6 when it is used in an I^2C (operation mode 4).	7	D3	-	-
	SCK6_1 (SCL6_1)		10	E3	6	-

Pin function	Pin name	Function description	Pin No			
			LQFP-80	BGA-96	LQFP-64 QFN-64	LQFP-48 QFN-48
Mode	MD0	Mode 0 pin. During normal operation, MD0="L" must be input. During serial programming to Flash memory, MD0="H" must be input.	37	L8	29	21
	MD1	Mode 1 pin. During serial programming to Flash memory, MD1="L" must be input.	36	K9	28	20
POWER	VCC	Power supply Pin	1	B1	1	1
	VCC	Power supply Pin	25	K1	18	14
	VCC	Power supply Pin	41	K11	33	-
	USBVCC	3.3V Power supply port for USB I/O	77	A4	61	45
GND	VSS	GND Pin	-	F1	-	-
	VSS	GND Pin	-	F2	-	-
	VSS	GND Pin	-	F3	-	-
	VSS	GND Pin	-	B2	-	-
	VSS	GND Pin	20	L1	16	12
	VSS	GND Pin	-	K2	-	-
	VSS	GND Pin	-	J3	-	-
	VSS	GND Pin	-	L6	-	-
	VSS	GND Pin	24	L4	-	-
	VSS	GND Pin	40	L11	32	24
	VSS	GND Pin	-	K10	-	-
	VSS	GND Pin	-	J9	-	-
	VSS	GND Pin	-	B10	-	-
	VSS	GND Pin	-	C9	-	-
	VSS	GND Pin	-	D11	-	-
	VSS	GND Pin	-	A11	-	-
	VSS	GND Pin	-	A7	-	-
	VSS	GND Pin	-	C3	-	-
	VSS	GND Pin	-	A5	-	-
	VSS	GND Pin	80	A1	64	48
CLOCK	X0	Main clock (oscillation) input pin	38	L9	30	22
	X0A	Sub clock (oscillation) input pin	26	L3	19	15
	X1	Main clock (oscillation) I/O pin	39	L10	31	23
	X1A	Sub clock (oscillation) I/O pin	27	K3	20	16
	CROUT_0	Built-in high-speed CR-osc clock output port	60	C10	-	-
	CROUT_1		72	A6	57	42
Analog POWER	AVCC	A/D converter and D/A converter analog power supply pin	50	H11	41	31
	AVRH	A/D converter analog reference voltage input pin	51	F11	42	32
Analog GND	AVSS	A/D converter and D/A converter GND pin	45	H10	37	28
	AVRL	A/D converter analog reference voltage input pin	52	G11	43	33
C pin	C	Power supply stabilization capacity pin	23	L2	17	13

Memory Map (2)



Refer to the programming manual for the detail of Flash main area.

■MB9AB40N/A40N/340N/140N/150R,MB9B520M/320M/120M Series Flash Programming Manual

Pin status type	Function group	Power-on reset or low-voltage detection state	INITX input state	Device internal reset state	Run mode or SLEEP mode state	Timer mode, RTC mode, or STOP mode state		Deep standby RTC mode or Deep standby STOP mode state		Return from Deep standby mode state
		Power supply unstable	Power supply stable		Power supply stable	Power supply stable		Power supply stable		Power supply stable
		-	INITX = 0	INITX = 1	INITX = 1	INITX = 1		INITX = 1		INITX = 1
		-	-	-	-	SPL = 0	SPL = 1	SPL = 0	SPL = 1	-
H	External interrupt enabled selected	Setting disabled	Setting disabled	Setting disabled	Maintain previous state	Maintain previous state	Maintain previous state	GPIO selected Internal input fixed at "0"	Hi-Z / Internal input fixed at "0"	GPIO selected
	GPIO selected	Hi-Z	Hi-Z / Input enabled	Hi-Z / Input enabled			Hi-Z / Internal input fixed at "0"			
	USB I/O pin	Setting disabled	Setting disabled	Setting disabled		Hi-Z at trans-mission/ Input enabled/ Internal input fixed at "0" at reception	Hi-Z at trans-mission/ Input enabled/ Internal input fixed at "0" at reception	Hi-Z / Input enabled	Hi-Z / Input enabled	Hi-Z / Input enabled
I	Analog input selected	Hi-Z	Hi-Z / Internal input fixed at "0" / Analog input enabled	Hi-Z / Internal input fixed at "0" / Analog input enabled	Hi-Z / Internal input fixed at "0" / Analog input enabled	Hi-Z / Internal input fixed at "0" / Analog input enabled	Hi-Z / Internal input fixed at "0" / Analog input enabled	Hi-Z / Internal input fixed at "0" / Analog input disabled	Hi-Z / Internal input fixed at "0" / Analog input disabled	Hi-Z / Internal input fixed at "0" / Analog input disabled
	NMIX selected	Setting disabled	Setting disabled	Setting disabled	Maintain previous state	Maintain previous state	Maintain previous state	WKUP input enabled	Hi-Z / WKUP input enabled	GPIO selected
	Resource other than above selected	Hi-Z	Hi-Z / Input enabled	Hi-Z / Input enabled			Hi-Z / Internal input fixed at "0"			
	GPIO selected									Maintain previous state
J	JTAG selected	Hi-Z	Pull-up / Input enabled	Pull-up / Input enabled	Maintain previous state	Maintain previous state	Maintain previous state	Maintain previous state	Maintain previous state	Maintain previous state
	GPIO selected	Setting disabled	Setting disabled	Setting disabled			Hi-Z / Internal input fixed at "0"	GPIO selected Internal input fixed at "0"	Hi-Z / Internal input fixed at "0"	GPIO selected

Pin status type	Function group	Power-on reset or low-voltage detection state	INITX input state	Device internal reset state	Run mode or SLEEP mode state	Timer mode, RTC mode, or STOP mode state		Deep standby RTC mode or Deep standby STOP mode state		Return from Deep standby mode state
		Power supply unstable	Power supply stable		Power supply stable	Power supply stable		Power supply stable		Power supply stable
		-	INITX = 0	INITX = 1	INITX = 1	INITX = 1		INITX = 1		INITX = 1
		-	-	-	-	SPL = 0	SPL = 1	SPL = 0	SPL = 1	-
K	Resource selected	Hi-Z	Hi-Z / Input enabled	Hi-Z / Input enabled	Maintain previous state	Maintain previous state	Hi-Z / Internal input fixed at "0"	GPIO selected Internal input fixed at "0"	Hi-Z / Internal input fixed at "0"	GPIO selected
	GPIO selected									
L	Analog output selected	Setting disabled	Setting disabled	Setting disabled	Maintain previous state	*3	*4	GPIO selected Internal input fixed at "0"	Hi-Z / Internal input fixed at "0"	GPIO selected
	External interrupt enabled selected					Maintain previous state	Maintain previous state			
	Resource other than above selected	Hi-Z	Hi-Z / Input enabled	Hi-Z / Input enabled			Hi-Z / Internal input fixed at "0"			
	GPIO selected									
M	Analog input selected	Hi-Z	Hi-Z / Internal input fixed at "0" / Analog input enabled	Hi-Z / Internal input fixed at "0" / Analog input enabled	Hi-Z / Internal input fixed at "0" / Analog input enabled	Hi-Z / Internal input fixed at "0" / Analog input enabled	Hi-Z / Internal input fixed at "0" / Analog input enabled	Hi-Z / Internal input fixed at "0" / Analog input enabled	Hi-Z / Internal input fixed at "0" / Analog input enabled	Hi-Z / Internal input fixed at "0" / Analog input enabled
	Resource other than above selected	Setting disabled	Setting disabled	Setting disabled	Maintain previous state	Maintain previous state	Hi-Z / Internal input fixed at "0"	GPIO selected Internal input fixed at "0"	Hi-Z / Internal input fixed at "0"	GPIO selected
	GPIO selected									

12. Electrical Characteristics

12.1 Absolute Maximum Ratings

Parameter	Symbol	Rating		Unit	Remarks
		Min	Max		
Power supply voltage*1, *2	V_{CC}	V_{SS} - 0.5	V_{SS} + 6.5	V	
Power supply voltage (for USB)*1, *3	$USBV_{CC}$	V_{SS} - 0.5	V_{SS} + 6.5	V	
Analog power supply voltage*1, *4	AV_{CC}	V_{SS} - 0.5	V_{SS} + 6.5	V	
Analog reference voltage*1, *4	AVRH	V_{SS} - 0.5	V_{SS} + 6.5	V	
Input voltage*1	V_I	V_{SS} - 0.5	V_{CC} + 0.5 (≤ 6.5V)	V	Except for USB pin
		V_{SS} - 0.5	$USBV_{CC}$ + 0.5 (≤ 6.5 V)	V	USB pin
		V_{SS} - 0.5	V_{SS} + 6.5	V	5 V tolerant
Analog pin input voltage*1	V_{IA}	V_{SS} - 0.5	AV_{CC} + 0.5 (≤ 6.5 V)	V	
Output voltage*1	V_O	V_{SS} - 0.5	V_{CC} + 0.5 (≤ 6.5 V)	V	
Clamp maximum current	I_{CLAMP}	-2	+2	mA	*8
Clamp total maximum current	$\Sigma [I_{CLAMP}]$		+20	mA	*8
L level maximum output current*5	I_{OL}	-	10	mA	4 mA type
			20	mA	12 mA type
			39	mA	The pin doubled as USB I/O
L level average output current*6	I_{OLAV}	-	4	mA	4 mA type
			12	mA	12 mA type
			16.5	mA	The pin doubled as USB I/O
L level total maximum output current	$\sum I_{OL}$	-	100	mA	
L level total average output current*7	$\sum I_{OLAV}$	-	50	mA	
H level maximum output current*5	I_{OH}	-	- 10	mA	4 mA type
			- 20	mA	12 mA type
			- 39	mA	The pin doubled as USB I/O
H level average output current*6	I_{OHAV}	-	- 4	mA	4 mA type
			- 12	mA	12 mA type
			- 18	mA	The pin doubled as USB I/O
H level total maximum output current	$\sum I_{OH}$	-	- 100	mA	
H level total average output current*7	$\sum I_{OHAV}$	-	- 50	mA	
Power consumption	P_D	-	300	mW	
Storage temperature	T_{STG}	- 55	+ 150	°C	

*1: These parameters are based on the condition that $V_{SS} = AV_{SS} = 0$ V.

*2: V_{CC} must not drop below V_{SS} - 0.5 V.

*3: $USBV_{CC}$ must not drop below V_{SS} - 0.5 V.

*4: Ensure that the voltage does not exceed V_{CC} + 0.5 V, for example, when the power is turned on.

*5: The maximum output current is defined as the value of the peak current flowing through any one of the corresponding pins.

*6: The average output current is defined as the average current value flowing through any one of the corresponding pins for a 100 ms period.

*7: The total average output current is defined as the average current value flowing through all of corresponding pins for a 100 ms.

(V_{CC} = AV_{CC} = $USBV_{CC}$ = 2.7V to 5.5V, V_{SS} = AV_{SS} = AVRL = 0V, T_A = - 40°C to + 105°C)

Parameter	Symbol	Pin name	Conditions		Value		Unit	Remarks
					Typ*2	Max*2		
Timer mode current	I_{CCT}	VCC	Main Timer mode	T_A = + 25°C, When LVD is off	4.1	4.8	mA	*1, *4
				T_A = + 105°C, When LVD is off	-	5.4	mA	*1, *4
	I_{CCT}		Sub Timer mode	T_A = + 25°C, When LVD is off	17	66	µA	*1, *5
				T_A = + 105°C, When LVD is off	-	835	µA	*1, *5
RTC mode current	I_{CCR}		RTC mode	T_A = + 25°C, When LVD is off	15	61	µA	*1, *5
				T_A = + 105°C, When LVD is off	-	680	µA	*1, *5
Stop mode current	I_{CCH}		Stop mode	T_A = + 25°C, When LVD is off	14	53	µA	*1
				T_A = + 105°C, When LVD is off	-	600	µA	*1
Deep Standby mode current	I_{CCRD}		Deep Standby RTC mode	T_A = + 25°C, When LVD is off, When RAM is off	2.2	11	µA	*1, *3, *5
				T_A = + 25°C, When LVD is off, When RAM is on	6.2	23	µA	*1, *3, *5
				T_A = + 105°C, When LVD is off, When RAM is off	-	155	µA	*1, *3, *5
				T_A = + 105°C, When LVD is off, When RAM is on		215	µA	*1, *3, *5
	I_{CCHD}		Deep Standby Stop mode	T_A = + 25°C, When LVD is off, When RAM is off	1.6	9.6	µA	*1, *3
				T_A = + 25°C, When LVD is off, When RAM is on	5.6	22	µA	*1, *3
				T_A = + 105°C, When LVD is off, When RAM is off	-	150	µA	*1, *3
				T_A = + 105°C, When LVD is off, When RAM is on		210	µA	*1, *3

*1: When all ports are fixed.

*2: V_{CC}=5.5 V

*3: RAM on/off setting is on-chip SRAM only.

*4: When using the crystal oscillator of 4 MHz(Including the current consumption of the oscillation circuit)

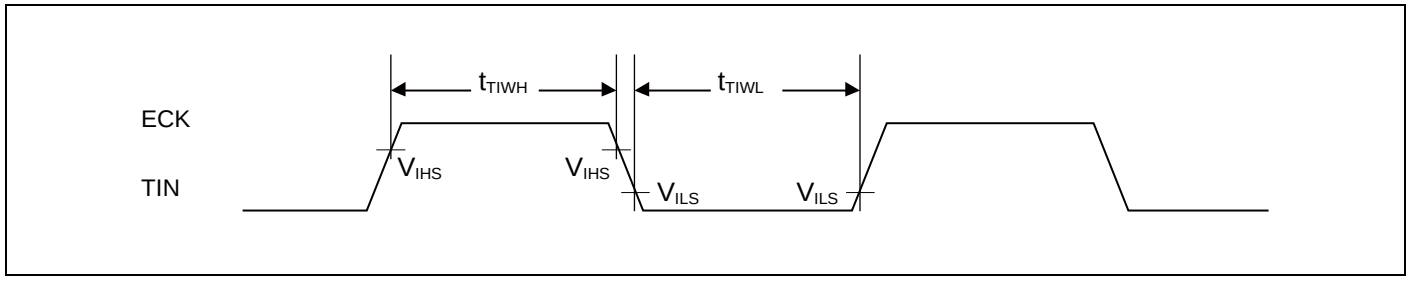
*5: When using the crystal oscillator of 32 kHz(Including the current consumption of the oscillation circuit)

12.4.8 Base Timer Input Timing

Timer input timing

(V_{CC} = 2.7V to 5.5V, V_{SS} = 0V, T_A = - 40°C to + 105°C)

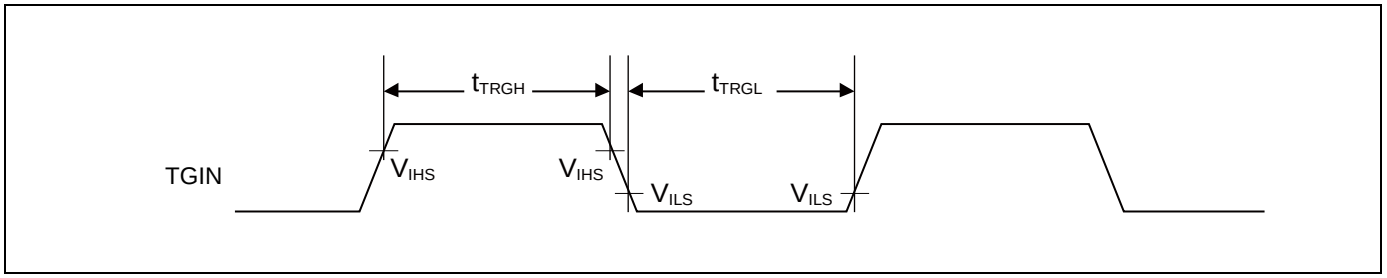
Parameter	Symbol	Pin name	Conditions	Value		Unit	Remarks
				Min	Max		
Input pulse width	t_{TIWH}, t_{TIWL}	TIOAn/TIOBn (when using as ECK, TIN)	-	$2t_{CYCP}$	-	ns	



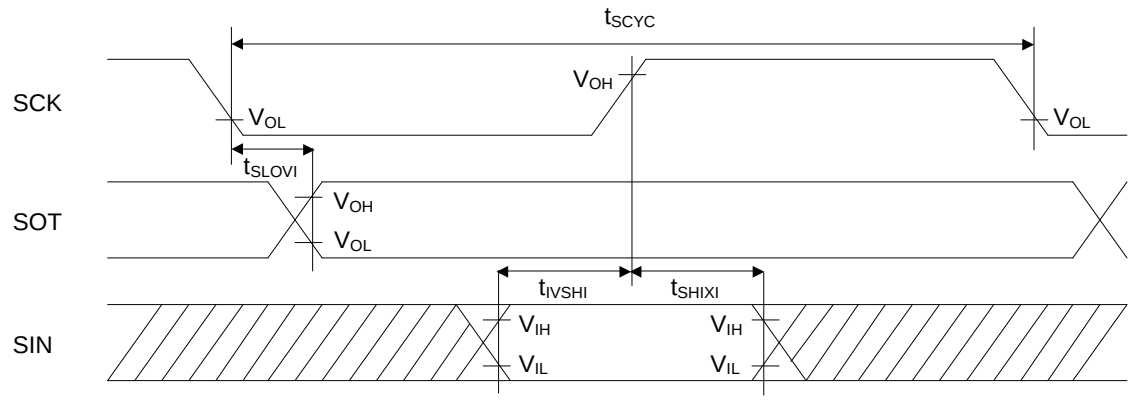
Trigger input timing

(V_{CC} = 2.7V to 5.5V, V_{SS} = 0V, T_A = - 40°C to + 105°C)

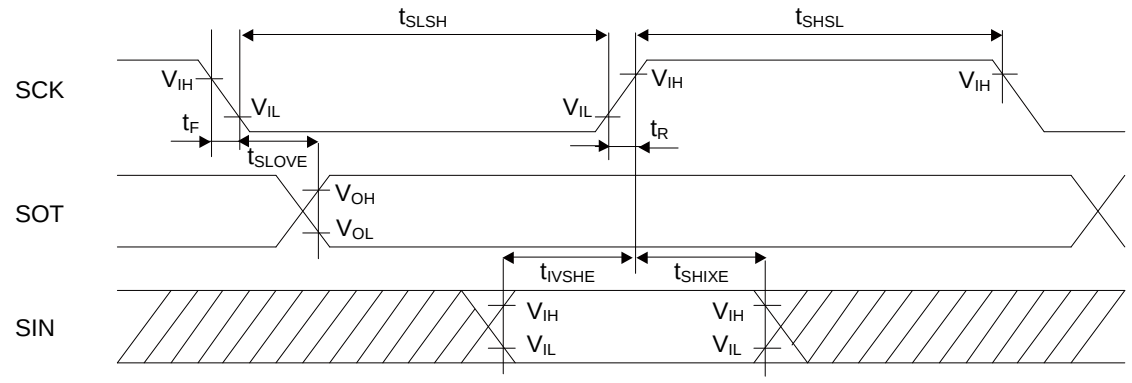
Parameter	Symbol	Pin name	Conditions	Value		Unit	Remarks
				Min	Max		
Input pulse width	t_{TRGH}, t_{TRGL}	TIOAn/TIOBn (when using as TGIN)	-	$2t_{CYCP}$	-	ns	



Note: t_{CYCP} indicates the APB bus clock cycle time.
About the APB bus number which the Base Timer is connected to, see “Block Diagram” in this data sheet.



Master mode



Slave mode

CSIO (SPI = 1, SCINV = 0)

(V_{CC} = 2.7V to 5.5V, V_{SS} = 0V, T_A = - 40°C to + 105°C)

Parameter	Symbol	Pin name	Conditions	V_{CC} < 4.5 V		V_{CC} ≥ 4.5 V		Unit
				Min	Max	Min	Max	
Serial clock cycle time	t_{SCYC}	SCKx	Master mode	$4t_{CYCP}$	-	$4t_{CYCP}$	-	ns
SCK ↑ → SOT delay time	t_{SHOVI}	SCKx, SOTx		- 30	+ 30	- 20	+ 20	ns
SIN → SCK ↓ setup time	t_{IVSLI}	SCKx, SINx		50	-	30	-	ns
SCK ↓→ SIN hold time	t_{SLIXI}	SCKx, SINx		0	-	0	-	ns
SOT → SCK ↓ delay time	t_{SOVLI}	SCKx, SOTx		$2t_{CYCP}$ - 30	-	$2t_{CYCP}$ - 30	-	ns
Serial clock L pulse width	t_{SLSH}	SCKx	Slave mode	$2t_{CYCP}$ - 10	-	$2t_{CYCP}$ - 10	-	ns
Serial clock H pulse width	t_{SHSL}	SCKx		t_{CYCP} + 10	-	t_{CYCP} + 10	-	ns
SCK ↑ → SOT delay time	t_{SHOVE}	SCKx, SOTx		-	50	-	30	ns
SIN → SCK ↓ setup time	t_{IVSLE}	SCKx, SINx		10	-	10	-	ns
SCK ↓→ SIN hold time	t_{SLIXE}	SCKx, SINx		20	-	20	-	ns
SCK falling time	t_F	SCKx		-	5	-	5	ns
SCK rising time	t_R	SCKx		-	5	-	5	ns

Notes:

- The above characteristics apply to CLK synchronous mode.
- t_{CYCP} indicates the APB bus clock cycle time.
  About the APB bus number which Multi-function serial is connected to, see “Block Diagram” in this data sheet.
- These characteristics only guarantee the same relocate port number.
  For example, the combination of SCKx_0 and SOTx_1 is not guaranteed.
- When the external load capacitance C_L = 30 pF.

12.4.12 I^2C Timing

(V_{CC} = 2.7V to 5.5V, V_{SS} = 0V, T_A = - 40°C to + 105°C)

Parameter	Symbol	Conditions	Standard-mode		Fast-mode		Unit	Remarks
			Min	Max	Min	Max		
SCL clock frequency	f_{SCL}	C_L = 30 pF, R = (V_P/I_{OL})*1	0	100	0	400	kHz	
(Repeated) START condition hold time SDA ↓ → SCL ↓	t_{HDSTA}		4.0	-	0.6	-	µs	
SCL clock L width	t_{LOW}		4.7	-	1.3	-	µs	
SCL clock H width	t_{HIGH}		4.0	-	0.6	-	µs	
(Repeated) START condition setup time SCL ↑ → SDA ↓	t_{SUSTA}		4.7	-	0.6	-	µs	
Data hold time SCL ↓ → SDA ↓ ↑	t_{HDDAT}		0	3.45*2	0	0.9*3	µs	
Data setup time SDA ↓ ↑ → SCL ↑	t_{SUDAT}		250	-	100	-	ns	
STOP condition setup time SCL ↑ → SDA ↑	t_{SUSTO}		4.0	-	0.6	-	µs	
Bus free time between STOP condition and START condition	t_{BUF}		4.7	-	1.3	-	µs	
Noise filter	t_{SP}	-	2 t_{CYCP}*4	-	2 t_{CYCP}*4	-	ns	

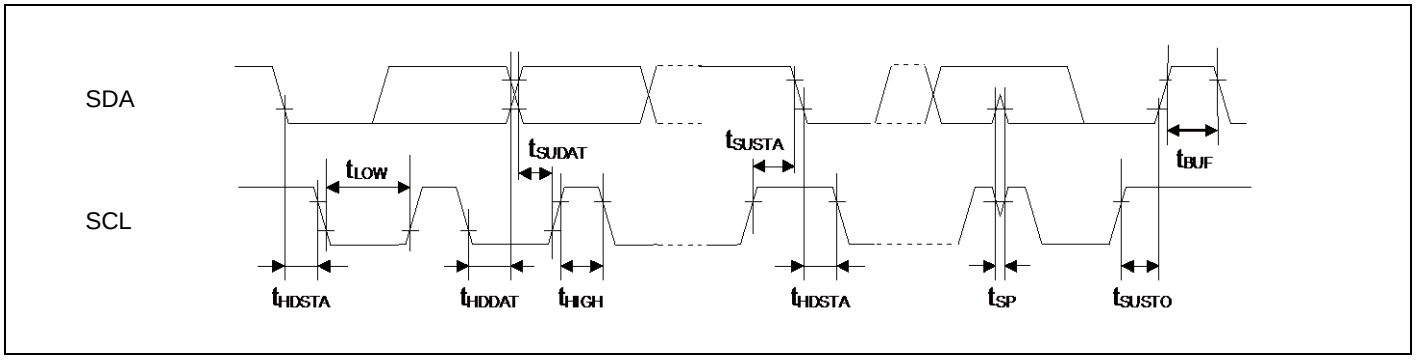
*1: R and C_L represent the pull-up resistor and load capacitance of the SCL and SDA lines, respectively.
V_P indicates the power supply voltage of the pull-up resistor and I_{OL} indicates V_{OL} guaranteed current.

*2: The maximum t_{HDDAT} must satisfy that it does not extend at least L period (t_{LOW}) of device's SCL signal.

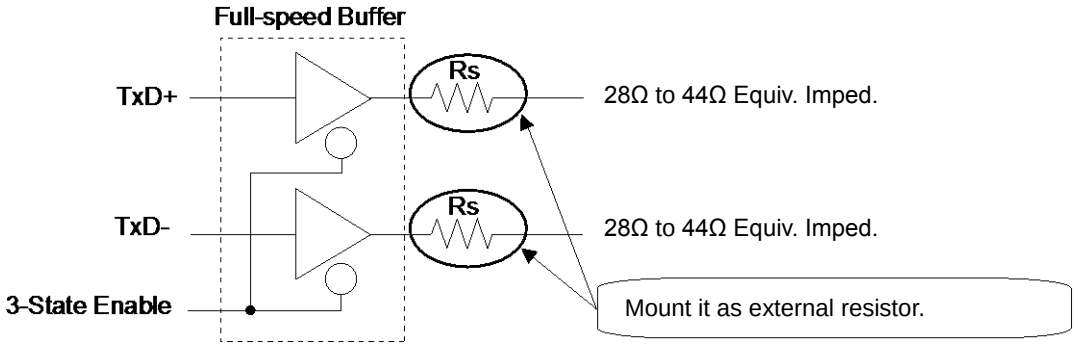
*3: A Fast mode I^2C bus device can be used on a Standard mode I^2C bus system as long as the device satisfies the requirement of "t_{SUDAT} ≥ 250 ns".

*4: t_{CYCP} is the APB bus clock cycle time.
About the APB bus number that I^2C is connected to, see “Block Diagram” in this data sheet.

To use Standard-mode, set the APB bus clock at 2 MHz or more
To use Fast-mode, set the APB bus clock at 8 MHz or more.

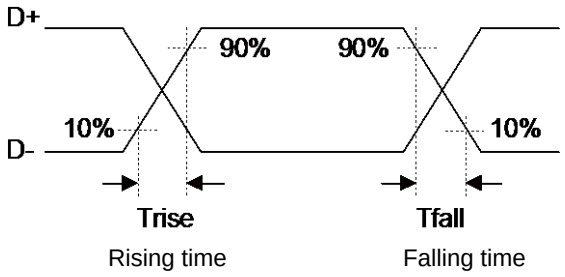


*6: USB Full-speed connection is performed via twist pair cable shield with 90 Ω ± 15% characteristic impedance (Differential Mode).
USB standard defines that output impedance of USB driver must be in range from 28 Ω to 44 Ω. So, discrete series resistor (Rs) addition is defined in order to satisfy the above definition and keep balance.
When using this USB I/O, use it with 25 Ω to 30 Ω (recommendation value 27 Ω) Series resistor Rs.



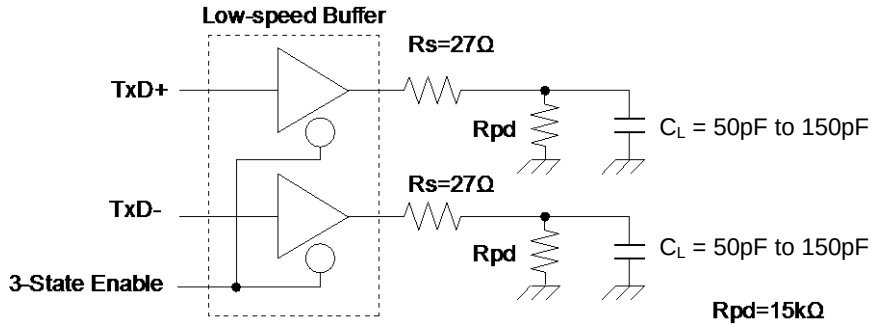
Rs series resistor 25Ω to 30Ω
Series resistor of 27Ω (recommendation value) must be added.
And, use "resistance with an uncertainty of 5% by E24 sequence".

*7: They indicate rising time (Trise) and falling time (Tfall) of the low-speed differential data signal.
They are defined by the time between 10% and 90% of the output signal voltage.

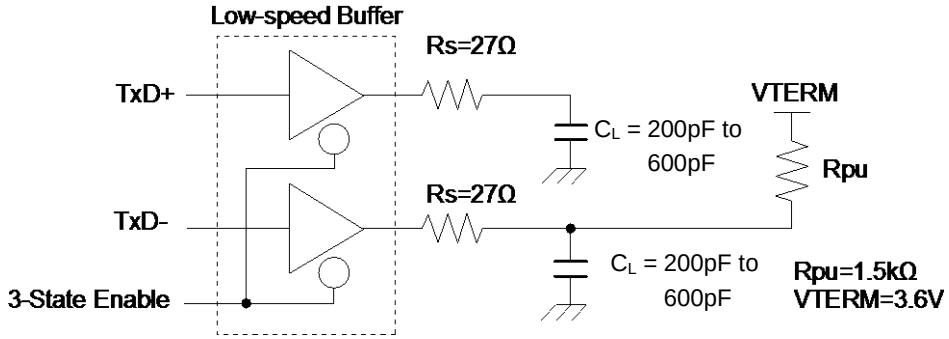


See "Low-Speed Load (Compliance Load)" for conditions of the external load.

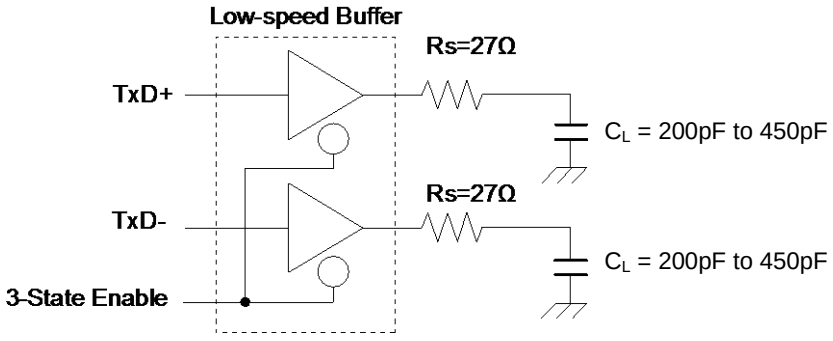
Low-Speed Load (Upstream Port Load) - Reference 1



Low-Speed Load (Downstream Port Load) - Reference 2



Low-Speed Load (Compliance Load)



12.8.2 Interrupt of Low-Voltage Detection

(T_A = - 40°C to + 105°C)

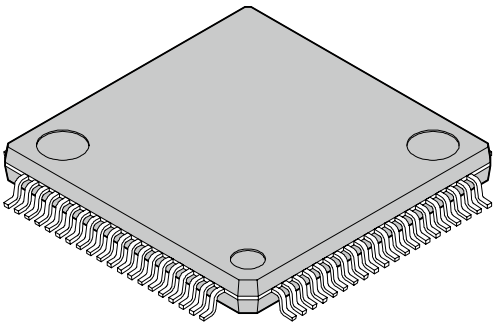
Parameter	Symbol	Conditions	Value			Unit	Remarks
			Min	Typ	Max		
Detected voltage	VDL	SVHI = 00011	2.58	2.80	3.02	V	When voltage drops
Released voltage	VDH		2.67	2.90	3.13	V	When voltage rises
Detected voltage	VDL	SVHI = 00100	2.76	3.00	3.24	V	When voltage drops
Released voltage	VDH		2.85	3.10	3.35	V	When voltage rises
Detected voltage	VDL	SVHI = 00101	2.94	3.20	3.46	V	When voltage drops
Released voltage	VDH		3.04	3.30	3.56	V	When voltage rises
Detected voltage	VDL	SVHI = 00110	3.31	3.60	3.89	V	When voltage drops
Released voltage	VDH		3.40	3.70	4.00	V	When voltage rises
Detected voltage	VDL	SVHI = 00111	3.40	3.70	4.00	V	When voltage drops
Released voltage	VDH		3.50	3.80	4.10	V	When voltage rises
Detected voltage	VDL	SVHI = 01000	3.68	4.00	4.32	V	When voltage drops
Released voltage	VDH		3.77	4.10	4.43	V	When voltage rises
Detected voltage	VDL	SVHI = 01001	3.77	4.10	4.43	V	When voltage drops
Released voltage	VDH		3.86	4.20	4.54	V	When voltage rises
Detected voltage	VDL	SVHI = 01010	3.86	4.20	4.54	V	When voltage drops
Released voltage	VDH		3.96	4.30	4.64	V	When voltage rises
LVD stabilization wait time	t_{LVDW}	-	-	-	8160 × t_{CYCP}*	µs	
LVD detection delay time	t_{LVDDL}	-	-	-	200	µs	

*: t_{CYCP} indicates the APB2 bus clock cycle time.

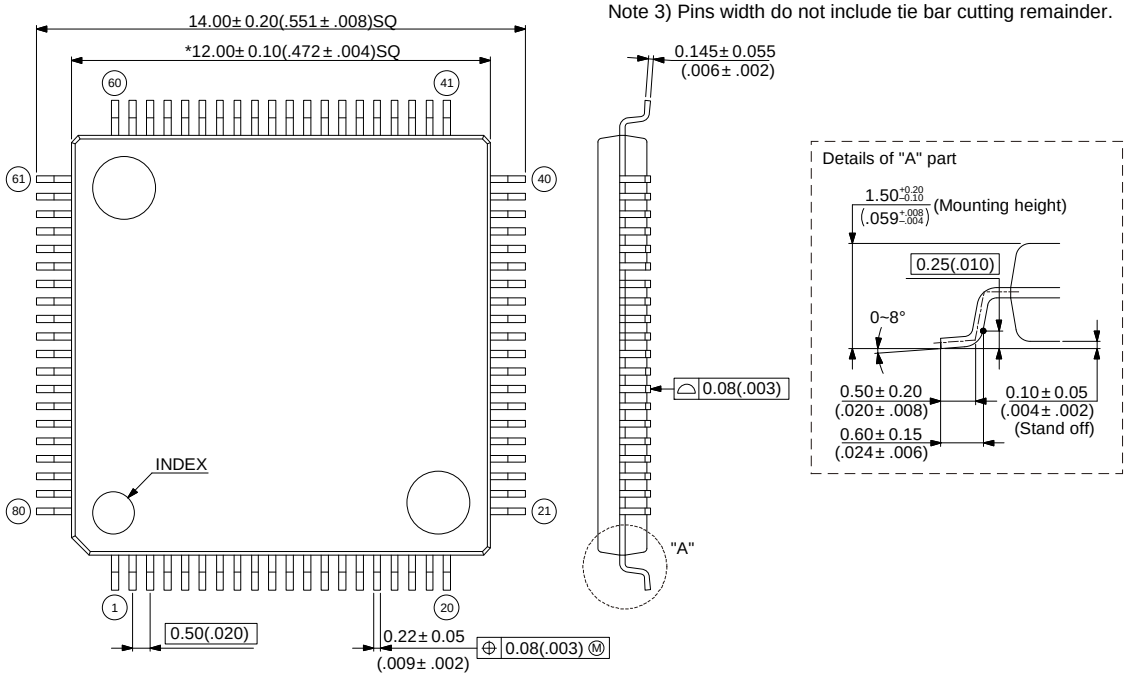
13. Ordering Information

Part number	On-chip Flash memory	On-chip SRAM	Package	Packing
MB9BF521KQN-G-AVE2	Main: 64 Kbyte Work: 32 Kbyte	16 Kbyte	Plastic・QFN (0.5 mm pitch), 48-pin (LCC-48P-M73)	Tray
MB9BF522KQN-G-AVE2	Main: 128 Kbyte Work: 32 Kbyte	16 Kbyte		
MB9BF524KQN-G-AVE2	Main: 256 Kbyte Work: 32 Kbyte	32 Kbyte		
MB9BF521KPMC-G-JNE2	Main: 64 Kbyte Work: 32 Kbyte	16 Kbyte	Plastic・LQFP (0.5 mm pitch), 48-pin (FPT-48P-M49)	
MB9BF522KPMC-G-JNE2	Main: 128 Kbyte Work: 32 Kbyte	16 Kbyte		
MB9BF524KPMC-G-JNE2	Main: 256 Kbyte Work: 32 Kbyte	32 Kbyte		
MB9BF521LQN-G-AVE2	Main: 64 Kbyte Work: 32 Kbyte	16 Kbyte	Plastic・QFN (0.5 mm pitch), 64-pin (LCC-64P-M24)	
MB9BF522LQN-G-AVE2	Main: 128 Kbyte Work: 32 Kbyte	16 Kbyte		
MB9BF524LQN-G-AVE2	Main: 256 Kbyte Work: 32 Kbyte	32 Kbyte		
MB9BF521LPMC1-G-JNE2	Main: 64 Kbyte Work: 32 Kbyte	16 Kbyte	Plastic・LQFP (0.5 mm pitch), 64-pin (FPT-64P-M38)	
MB9BF522LPMC1-G-JNE2	Main: 128 Kbyte Work: 32 Kbyte	16 Kbyte		
MB9BF524LPMC1-G-JNE2	Main: 256 Kbyte Work: 32 Kbyte	32 Kbyte		
MB9BF521LPMC-G-JNE2	Main: 64 Kbyte Work: 32 Kbyte	16 Kbyte	Plastic・LQFP (0.65 mm pitch), 64-pin (FPT-64P-M39)	
MB9BF522LPMC-G-JNE2	Main: 128 Kbyte Work: 32 Kbyte	16 Kbyte		
MB9BF524LPMC-G-JNE2	Main: 256 Kbyte Work: 32 Kbyte	32 Kbyte		
MB9BF521MPMC-G-JNE2	Main: 64 Kbyte Work: 32 Kbyte	16 Kbyte	Plastic・LQFP (0.5 mm pitch), 80-pin (FPT-80P-M37)	
MB9BF522MPMC-G-JNE2	Main: 128 Kbyte Work: 32 Kbyte	16 Kbyte		
MB9BF524MPMC-G-JNE2	Main: 256 Kbyte Work: 32 Kbyte	32 Kbyte		
MB9BF521MPMC1-G-JNE2	Main: 64 Kbyte Work: 32 Kbyte	16 Kbyte	Plastic・LQFP (0.65 mm pitch), 80-pin (FPT-80P-M40)	
MB9BF522MPMC1-G-JNE2	Main: 128 Kbyte Work: 32 Kbyte	16 Kbyte		
MB9BF524MPMC1-G-JNE2	Main: 256 Kbyte Work: 32 Kbyte	32 Kbyte		
MB9BF521MBGL-GE1	Main: 64 Kbyte Work: 32 Kbyte	16 Kbyte	Plastic・PFBGA (0.5 mm pitch), 96-pin (BGA-96P-M07)	Tray
MB9BF522MBGL-GE1	Main: 128 Kbyte Work: 32 Kbyte	16 Kbyte		
MB9BF524MBGL-GE1	Main: 256 Kbyte Work: 32 Kbyte	32 Kbyte		

14. Package Dimensions

80-pin plastic LQFP		
 (FPT-80P-M37)	Lead pitch	0.50 mm
	Package width × package length	12.00 mm × 12.00 mm
	Lead shape	Gullwing
	Lead bend direction	Normal bend
	Sealing method	Plastic mold
	Mounting height	1.70 mm MAX
	Weight	0.47 g

80-pin plastic LQFP
(FPT-80P-M37)



Note 1) * : These dimensions do not include resin protrusion.
Note 2) Pins width and pins thickness include plating thickness.
Note 3) Pins width do not include tie bar cutting remainder.

Dimensions in mm (inches).
Note: The values in parentheses are reference values.